

30V N-CHANNEL ENHANCEMENT MODE MOSFET WITH SCHOTTKY DIODE POWERDI®

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	Package	I _D T _A = +25°C
30V	10mΩ @ V _{GS} = 10V	POWERDI3333-8	12 A
307	15mΩ @ $V_{GS} = 4.5V$	POWERDISSS-0	9.5A

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

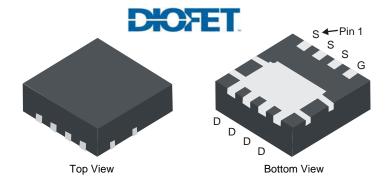
- Backlighting
- Power Management Functions
- DC-DC Converters

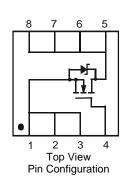
Features

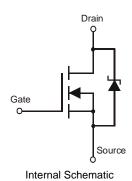
- DIOFET utilizes a unique patented process to monolithically integrate a MOSFET and a Schottky in a single die to deliver:
 - Low R_{DS(ON)} minimize conduction losses
 - Low V_{SD} reducing the losses due to body diode conduction
 - Low Q_{rr} lower Q_{rr} of the integrated Schottky reduces body diode switching losses
 - Low gate capacitance (Q_g/Q_{gs}) ratio reduces risk of shootthrough or cross conduction currents at high frequencies
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (approximate







Ordering Information (Note 4)

Part Number	Case	Packaging
DMG7702SFG-7	POWERDI3333-8	2000/Tape & Reel
DMG7702SFG-13	POWERDI3333-8	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.



Marking Information



G72 = Product Type Marking Code YYWW = Date Code Marking YY = Last digit of year (ex: 11 = 2011) WW = Week code (01 ~ 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note C) / 40/	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	12 9.5	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	16.0 12.7	А
Continuous Dusin Compart (Nata C) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	9.5 7.5	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	13.0 10.3	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	90	Α		
Maximum Continuous Body Diode Forward Current (Note 6)			Is	3.5	A
Avalanche Current (Note 7) L = 0.1mH			I _{AR}	17	A
Repetitive Avalanche Energy (Note 7) L = 0.1mH			E _{AR}	43	mJ

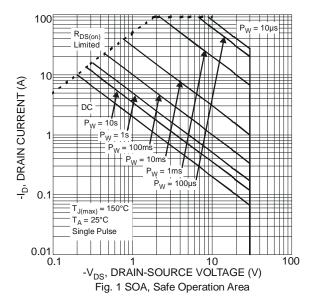
Thermal Characteristics

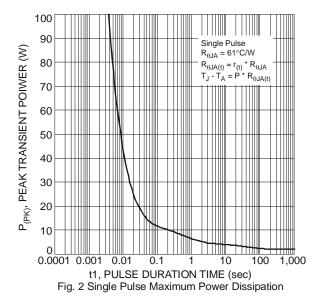
Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	р	0.89	W
Total Fower Dissipation (Note 5)	$T_A = +70^{\circ}C$	P_{D}	0.55	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	<u> </u>	145	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	74	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	р	2.2	W
Total Fower Dissipation (Note 6)	$T_A = +70^{\circ}C$	P_{D}	1.3	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	<u> </u>	58	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	31	
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	11	
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C

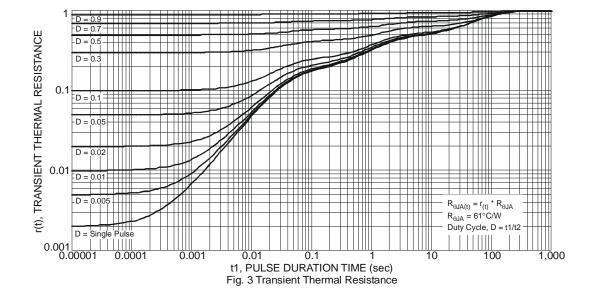
Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 7. I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep T_J = +25°C









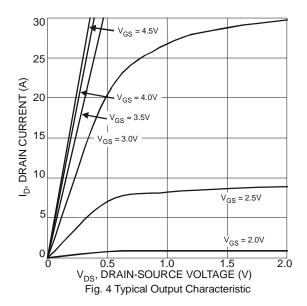


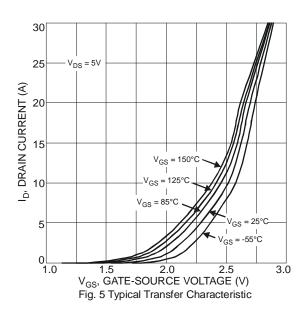
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	-	-	100	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(th)}	1.0	1.5	2.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	D	1	7.3	10	mΩ	$V_{GS} = 10V, I_D = 13.5A$	
Static Drain-Source On-Resistance	R _{DS} (ON)	-	10	15	11177	V _{GS} = 4.5V, I _D = 11A	
Forward Transfer Admittance	Y _{fs}	-	22	-	S	$V_{DS} = 5V, I_{D} = 10.0A$	
Diode Forward Voltage	V _{SD}	-	0.45	0.55	V	V _{GS} = 0V, I _S = 1A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	1	1296	4310	pF	15)/)/ 0)/	
Output Capacitance	Coss	-	415	-	pF	$V_{DS} = 15V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	-	204	-	pF	-1 = 1.0lvii iz	
Gate Resistance	Rg	0.26	1.6	2.7	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge V _{GS} = 4.5V	Qg	-	14.7	-	nC		
Total Gate Charge V _{GS} = 10V	Q_g	-	31.6	-	nC	15)/)/ 10)/ 12.54	
Gate-Source Charge	Q_{gs}	-	3.5	-	nC	$V_{DS} = 15V, V_{GS} = 10V, I_D = 13.5A$	
Gate-Drain Charge	Q _{qd}	-	5.0	-	nC		
Turn-On Delay Time	t _{D(on)}	-	15.8	-	ns		
Turn-On Rise Time	t _r		27.8	-	ns	$V_{GS} = 10V, V_{DS} = 15V,$	
Turn-Off Delay Time	t _{D(off)}	ı	29.7	-	ns	$R_G = 3\Omega$, $I_D = 8.8A$	
Turn-Off Fall Time	t _f		13.6	-	ns		
Reverse Recovery Time	t _{rr}	ı	13.1	-	ns	$I_F = 13.5A$, $di/dt = 100A/\mu s$	
Reverse Recovery Charge	Q _{rr}	ı	4.3	-	nC	$I_F = 13.5A$, $di/dt = 100A/\mu s$	

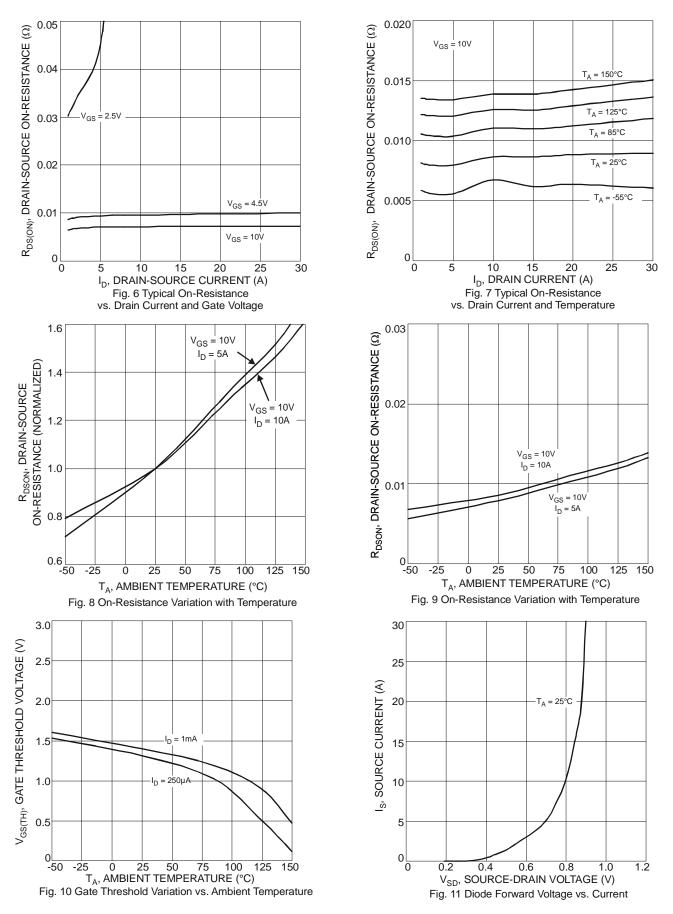
Notes: 8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

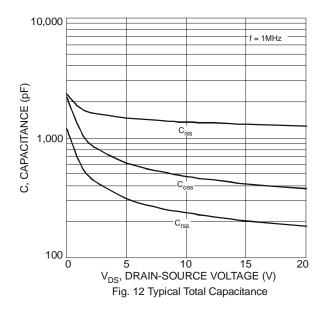


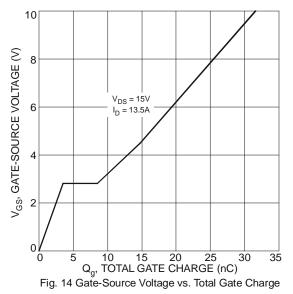


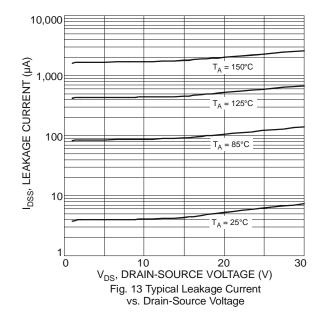






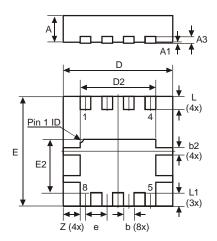






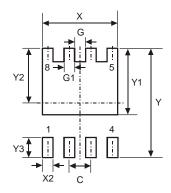


Package Outline Dimensions



POWERDI3333-8				
Dim	Min	Max	Тур	
D	3.25	3.35	3.30	
Е	3.25	3.35	3.30	
D2	2.22	2.32	2.27	
E2	1.56	1.66	1.61	
Α	0.75	0.85	0.80	
A1	0	0.05	0.02	
А3	_	_	0.203	
b	0.27	0.37	0.32	
b2	_	_	0.20	
L	0.35	0.45	0.40	
L1	_	_	0.39	
е	_	_	0.65	
Z	_	_	0.515	
All I	All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)		
С	0.650		
G	0.230		
G1	0.420		
Y	3.700		
Y1	2.250		
Y2	1.850		
Y3	0.700		
Х	2.370		
X2	0.420		



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